

CSM-360 LEDs



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Features:

- Extremely high optical output: Over 6,000 lumens from a single package (white)
- Extremely high efficiency: Over 100 lumens per watt at 3.15A
- High thermal conductivity package junction to heat sink thermal resistance of only 0.90 °C/W
- Four large, monolithic chip with uniform emitting area of 36 mm²
- Lumen maintenance of greater than 70% after 60,000 hours
- Environmentally friendly: RoHS compliant
- Variable drive currents: less than 1 A through 6.3 A
- High reliability

Applications

- High Bay
- Roadway and Parking Area
- Outdoor Area Lighting
- Transportation

- Wide Area Lighting
- Architectural Lighting
- High Intensity General Lighting





Technology Overview

Luminus Big Chip LEDs™ benefit from a suite of innovations in the fields of chip technology, packaging and thermal management. These breakthroughs allow illumination engineers and designers to achieve solutions that are high brightness and high efficiency.

Photonic Lattice Technology

Luminus' photonic lattice technology enables large area LED chips with uniform brightness over the entire LED chip surface. The optical power and brightness produced by these large monolithic chips enable solutions which replace arc and halogen lamps where arrays of traditional high power LEDs cannot.

For red, green and blue LEDs, the photonic lattice structures extract more light and create radiation patterns that are more collimated than traditional LEDs. Having higher collimation from the source increases optical collection efficiencies and simplifies optical designs.

Packaging Technology

Thermal management is critical in high power LED applications. With a thermal resistance from junction to heat sink of 0.90° C/W. Luminus CSM-360 LEDs have the lowest thermal resistance of any LED on the market. This allows the LED to be driven at higher current densities while maintaining a low junction temperature, thereby resulting in brighter solutions

and longer lifetimes.

Reliability

Designed from the ground up, Luminus Big Chip LEDs are one of the most reliable light sources in the world today. Big Chip LEDs have passed a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity, and have been fully qualified for use in extreme high power and high current applications. With very low failure rates and median lifetimes that typically exceed 60,000 hours, Luminus Big Chip LEDs are ready for even the most demanding applications.

Environmental Benefits

Luminus LEDs help reduce power consumption and the amount of hazardous waste entering the environment. All Big Chip LED products manufactured by Luminus are RoHS compliant and free of hazardous materials, including lead and mercury.

Understanding Big Chip LED Test Specifications

Every Luminus LED is fully tested to ensure that it meets the high quality standards expected from Luminus' products.

Testing Temperature

Luminus core board products are typically measured in such a way that the characteristics reported agree with how the devices will actually perform when incorporated into a system. This measurement is accomplished by mounting the devices on a 40°C heat sink and allowing the device to reach thermal equilibrium while fully powered. Only after the device reaches equilibrium are the measurements taken. This method of measurement ensures that Luminus Big Chip LEDs perform in the field just as they are specified.

Luminus surface mount LEDs are typically tested with a 20mSec input pulse and a junction temperature of 25°C. Expected flux values in real world operation can be extrapolated based on the information contained within this product data sheet.

Multiple Operating Points (3.15, 6.3 A)

The tables on the following pages provide typical optical and electrical characteristics. Since the LEDs can be operated over a wide range of drive conditions (currents from less than 1.0 A to 6.3 A, and duty cycle from <1% to 100%), multiple drive conditions are listed.

CSM-360 LEDs are production tested at 3.15 A. The values shown at 6.3 are for additional reference at other possible drive conditions.



CSM-360 White Binning Structure

CSM-360 LEDs are tested for luminous flux and chromaticity at a drive current of 3.15 A (350 mA/mm²) and placed into one of the following luminous flux (FF) and chromaticity (WW) bins:

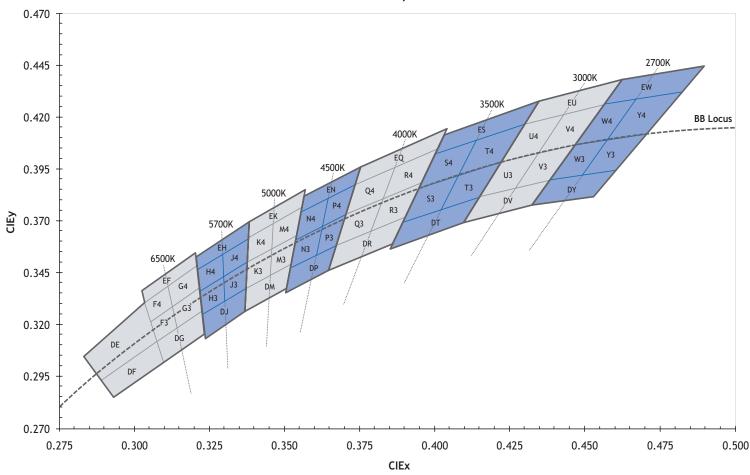
Flux Bins ($T_i = 25$ °C)

Flux Bin (FF)	Minumum Flux (lm) @ 3.15A Maximum Flux (lm) @ 3.15			
S	1,750	2,100		
Т	2,100	2,500		
U	2,500	3,000		
V	3,000	3,600		
X	3,600	4,300		

^{*}Note: Luminus maintains a +/- 6% tolerance on flux measurements.

Chromaticity Bins

Luminus' Standard Chromaticity Bins: 1931 CIE Curve







The following tables describe the four chromaticity points that bound each chromaticity bin. Chromaticity bins are grouped together based on the color temperature.

6500K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.307	0.311	
DG	0.322	0.326	
	0.323	0.316	
	0.309	0.302	
	0.305	0.321	
F3*	0.313	0.329	
Lo	0.315	0.319	
	0.307	0.311	
	0.303	0.330	
F4*	0.312	0.339	
F4"	0.313	0.329	
	0.305	0.321	
	0.313	0.329	
C2*	0.321	0.337	
G3*	0.322	0.326	
	0.315	0.319	
	0.312	0.339	
G4*	0.321	0.348	
	0.321	0.337	
	0.313	0.329	
	0.302	0.335	
FF	0.320	0.354	
EF .	0.321	0.348	
	0.303	0.330	
	0.283	0.304	
DE	0.303	0.330	
DE	0.307	0.311	
	0.289	0.293	
	0.289	0.293	
DE	0.307	0.311	
DF	0.309	0.302	
	0.293	0.285	

5700K Chromaticity Bins				
Bin Code (WW)	CIEx	CIEy		
	0.322	0.324		
LDJ	0.337	0.337		
	0.336	0.326		
	0.323	0.314		
	0.321	0.335		
H3*	0.329	0.342		
Пэ	0.329	0.331		
	0.322	0.324		
	0.321	0.346		
H4*	0.329	0.354		
П4"	0.329	0.342		
	0.321	0.335		
J3*	0.329	0.342		
	0.337	0.349		
	0.337	0.337		
	0.330	0.331		
	0.329	0.354		
ј Ј4*	0.338	0.362		
J4"	0.337	0.349		
	0.329	0.342		
	0.320	0.352		
FU	0.338	0.368		
EH	0.338	0.362		
	0.321	0.346		

^{*}Sub-bins within ANSI defined quadrangles per ANSI C78.377-2008





5000K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.338	0.368	
EK	0.356	0.384	
EN	0.355	0.376	
	0.338	0.362	
	0.337	0.349	
V2*	0.345	0.355	
K3*	0.345	0.343	
	0.337	0.337	
	0.338	0.362	
I/ 4 ¥	0.347	0.369	
K4*	0.345	0.355	
	0.337	0.349	
	0.345	0.355	
M3*	0.353	0.349	
1013	0.352	0.372	
	0.344	0.343	
	0.346	0.369	
N.4.4*	0.355	0.376	
M4*	0.353	0.362	
	0.345	0.355	
	0.337	0.337	
DM	0.352	0.349	
DIVI	0.350	0.337	
	0.336	0.326	

4500K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.356	0.384	
EN	0.376	0.396	
EIN	0.374	0.387	
	0.355	0.374	
	0.353	0.360	
N3*	0.361	0.366	
IN5"	0.359	0.352	
	0.351	0.347	
	0.355	0.374	
NIAY	0.364	0.381	
N4*	0.361	0.366	
	0.353	0.360	
P3*	0.361	0.366	
	0.370	0.373	
	0.367	0.358	
	0.359	0.352	
	0.364	0.381	
D.4*	0.374	0.387	
P4*	0.370	0.373	
	0.361	0.366	
	0.351	0.347	
DD	0.367	0.358	
DP	0.364	0.346	
	0.350	0.335	

*Sub-bins within ANSI defined quadrangles per ANSI C78.377-2008





4000K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.376	0.396	
EQ	0.404	0.414	
EQ	0.401	0.404	
	0.374	0.387	
	0.370	0.373	
O2*	0.382	0.380	
Q3*	0.378	0.365	
	0.367	0.358	
	0.374	0.387	
0.4*	0.387	0.396	
Q4*	0.382	0.380	
	0.370	0.373	
	0.382	0.380	
	0.395	0.388	
R3*	0.390	0.372	
	0.378	0.365	
	0.387	0.396	
D.4*	0.401	0.404	
R4*	0.395	0.388	
	0.382	0.380	
	0.367	0.358	
DD	0.390	0.372	
DR	0.386	0.359	
	0.364	0.346	

3500K Chromaticity Bins				
Bin Code (WW)	CIEx	CIEy		
	0.403	0.411		
ES	0.435	0.427		
E2	0.430	0.417		
	0.400	0.402		
	0.394	0.385		
C2*	0.407	0.392		
S3*	0.402	0.375		
	0.389	0.369		
	0.400	0.402		
C 4×	0.415	0.409		
S4*	0.407	0.392		
	0.394	0.385		
	0.407	0.392		
T2*	0.422	0.399		
T3*	0.415	0.381		
	0.402	0.375		
	0.415	0.409		
T4*	0.430	0.417		
T4*	0.422	0.399		
	0.407	0.392		
	0.389	0.369		
DT	0.415	0.381		
DT	0.409	0.369		
	0.385	0.357		

 $[*]Sub-bins\ within\ ANSI\ defined\ quadrangles\ per\ ANSI\ C78.377-2008$





3000K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.435	0.427	
EU	0.462	0.437	
E0	0.456	0.426	
	0.430	0.417	
	0.422	0.399	
112*	0.434	0.403	
U3*	0.426	0.385	
	0.415	0.381	
	0.430	0.417	
114*	0.443	0.421	
U4*	0.434	0.403	
	0.422	0.399	
V2*	0.434	0.403	
	0.447	0.408	
V3*	0.437	0.389	
	0.426	0.385	
	0.443	0.421	
V4*	0.456	0.426	
V4"	0.447	0.408	
	0.434	0.403	
	0.415	0.381	
DV	0.437	0.389	
DV	0.431	0.377	
	0.409	0.369	

2700K Chromaticity Bins			
Bin Code (WW)	CIEx	CIEy	
	0.462	0.437	
EW	0.488	0.444	
EVV	0.481	0.432	
	0.456	0.426	
	0.447	0.408	
W3*	0.458	0.410	
VVS	0.448	0.392	
	0.437	0.389	
	0.456	0.426	
W4*	0.469	0.429	
VV4*	0.458	0.410	
	0.447	0.408	
	0.458	0.410	
Y3*	0.70	0.413	
13"	0.459	0.394	
	0.448	0.392	
	0.469	0.429	
V/4*	0.481	0.432	
Y4*	0.470	0.413	
	0.458	0.410	
	0.437	0.389	
DV	0.459	0.394	
DY	0.452	0.382	
	0.431	0.377	

^{*}Sub-bins within ANSI defined quadrangles per ANSI C78.377-2008



WW

FF



Product Shipping & Labeling Information

All CSM-360 products are packaged and labeled with their respective bin as outlined in the tables from pages 3 to 6. When shipped, each package will only contain one bin. The part number designation is as follows:

Product Family	Chip Area	Color	Package Configuration	Flux Bin	Chromaticity Bin
Chip on Board (Lens)	36.0 mm ²	CCT & CRI See Note 1 below	Internal Code	See page 3 for bins	See page 4-6 for bins

WNNX

D22

Note 1: WNNX nomenclature corresponds to the following:

360

W = White

CSM

NN = color temperature, where:

65 corresponds to 6500K

X = color rendering index, where:

S (standard) corresponds to a typical CRI of 70

Note 2: Some flux and chromaticity bins may have limited availability. Application specific bin kits, consisting of multiple bins, may be available. For ordering information, please refer to page 14 and reference PDS-001850: CSM-360 Binning & Labeling document.

Example:

The part number CSM-360-W65S-D22-GV-G4 refers to a 6500K standard CRI white, CSM-360 emitter, with a flux range from 3,000 to 3,600 lumens and a chromaticity value within the box defined by the four points (0.313, 0.338), (0.321, 0.348), (0.322, 0.336), (0.312, 0.328).



Electrical Characteristics¹

Optical and Electrical Characteristics (T₁ = 25 °C)

Drive Condition ²		3.15 A	6.3 A	
Parameter Symbol		Values at Test Currents	Typical Values at Indicated Current ³	Unit
Current Density	j	0.35	0.70	A/mm ²
	V _{F, min}	11.00		V
Forward Voltage	$V_{F, typ}$	13.14	14.15	V
	V _{F, max}	17.60		V

Common Characteristics

Parameter	Symbol	Values	Unit
Viewing Angle	2 θ _{1/2}	115	
Emitting Area		36.0	mm²
Emitting Area Dimensions		6 x 6	mm×mm
Forward Voltage Temperature Coefficient⁴		-3.07	mV/ºC

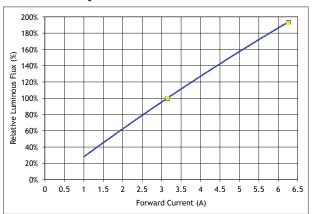
Absolute Maximum Ratings

Parameter	Symbol	Values	Unit
Maximum Current ⁵		6.3	А
Maximum Reverse Current		N/A	
Maximum Junction Temperature ⁶	T _{j-max}	150	°C
Storage Temperature Range		-40/+100	۰C

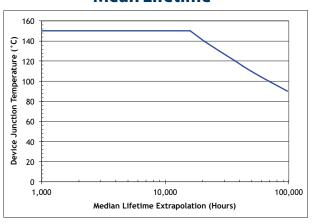
- Note 1: Listed drive conditions are typical for common applications. CSM-360 White devices can be driven at currents ranging from <1A to 6.3A and at duty cycles ranging from <1% to 100%. Drive current and duty cycle should be adjusted as necessary to maintain the junction temperature desired to meet application lifetime requirements.
- Note 2: Unless otherwise noted, values listed are typical.
- Note 3: Forward voltage temperature coefficient at 3.15A. Contact Luminus for value at other drive conditions.
- Note 4: CSM-360 White devices are designed for operation to an absolute maximum forward drive current 6.3A. Product lifetime data is specified at recommended forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to recommended forward drive currents. Actual device lifetimes will also depend on junction temperature. Refer to Reliability Application Note for CSM-360-W for further information. In pulsed operation, rise time from 10-90% of forward current should be larger than 0.5 microseconds.
- Note 5: Lifetime dependent on LED junction temperature. Thermal calculations based on input power and thermal management system should be performed to ensure T_i is maintained below T_{imax} rating or life will be reduced. Refer to Reliability Application Note for further information.
- Note 6: CIE measurement uncertainty for white devices is estimated to be \pm 0.01.
- Note 7: Special design considerations must be observed for operation under 1A. Please contact Luminus for further information.
- Note 8: Caution must be taken not to stare at the light emitted from these LEDs. Under special circumstances, the high intensity could damage the eye.



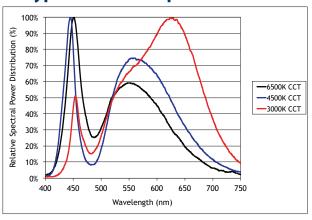
Relative Output Flux vs. Forward Current¹



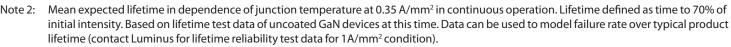
Mean Lifetime²



Typical Relative Spectral Power⁴



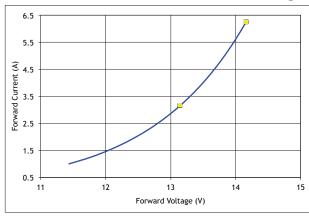
Note 1: Yellow squares indicate typical operating conditions.



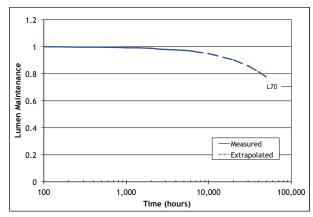
Note 3: Lumen maintenance in dependence of time at 0.35 A/mm² in continuous operation with junction temperatures of 100 °C.

Note 4: Typical spectrum at current density of 0.35 A/mm² in continuous operation.

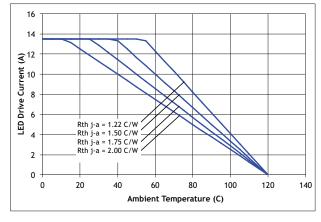
Forward Current vs. Forward Voltage



Lumen Maintenance vs. Time³

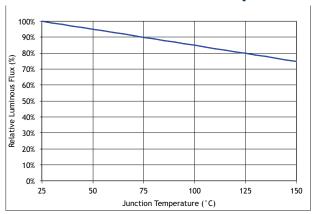


Current Derating Curve



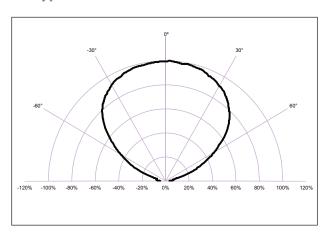


Relative Flux vs. Junction Temperature

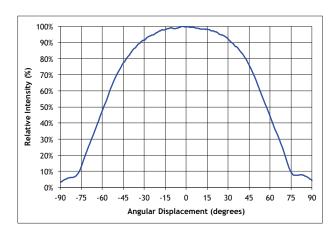


Typical Radiation Patterns

Typical Polar Radiation Pattern for White



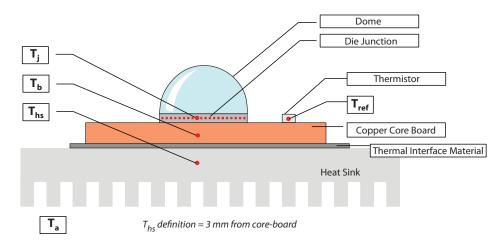
Typical Angular Radiation Pattern for White







Thermal Resistance



Typical Thermal Resistance

R _{θj-b} 1	0.77 °C/W
R _{@b-hs} 1	0.13 °C/W
$R_{\theta j-hs}^2$	0.90 °C/W
$R_{\theta j\text{-ref}}^{1}$	0.69 °C/W

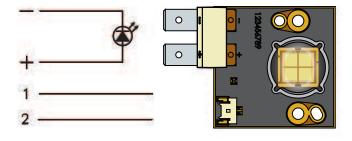
Note 1: Thermal resistance values are based on FEA model results correlated to measured $R_{\theta j \text{-} hs}$ data.

Note 2: Thermal resistance is measured using a SAC305 solder, a Bergquist Al-clad MCPCB, and eGraf 1205 thermal interface material.

Thermistor Information

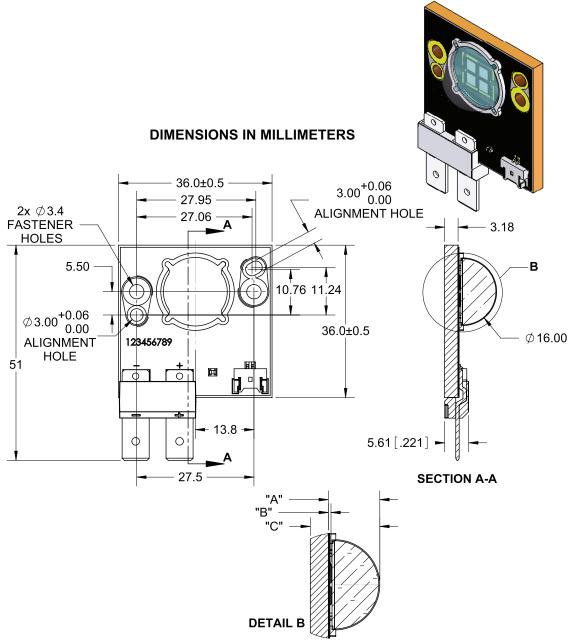
The thermistor used in CSM-360 devices mounted on coreboards is from Murata Manufacturing Co. The global part number is NCP15XH103J03RC. Please see http://www.murata.com/ for details on calculating thermistor temperature.

Electrical Pinout





Mechanical Dimensions - CSM-360 Emitter



DIMENSION NAME	DESCRIPTION	NOMINAL DIMENSION	TOLERANCE
"A"	TOP OF SUBSTRATE TO TOP OF LENS	9.05	±0.35
"B"	EMITTING AREA TO TOP OF SUBSTRATE	.47	±0.05
"C"	BOTTOM OF COREBOARD TO TOP OF LENS	12.20	±0.50

Recommended connector for Anode and Cathode: Panduit Disco Lok™ Series P/N: DNG14-250FL-C Thermistor Connector: MOLEX P/N 53780-0270. Recommended Female: MOLEX P/N 51146-0200 or equivalent For detailed drawing please refer to DWG-001365 document





Ordering Information

Ordering Part Number 1,2	Color	Description
CSM-360-WDLS-D22-GT150	6500K White 5700K White	
CSM-360-WCLS-D22-GT450	4500K White 4000K White	White Big Chip LED™ CSM-360 consisting of four 9 mm² LEDs wired in series, thermistor, connector, and a copper-core PCB
CSM-360-WWRM-D22-GR750	3000K White 2700K White	

Note 1: GT150 - denotes a bin kit comprising of all flux and chromaticity bins at the 6500K and 5700K color points.

 $GT450-denotes\ a\ bin\ kit\ comprising\ of\ all\ flux\ and\ chromaticity\ bins\ at\ the\ 4500K\ and\ 4000K\ color\ points.$

GR750 - denotes a bin kit comprising of all flux and chromaticity bins at the 3000K and 2700K color points.

Note 2: For ordering information on all available bin kits, please see PDS-001850: CSM-360 W Binning and Labeling document.

Note 3: Standard packaging increment (SPI) is 10.

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